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Optical and electronic properties of SiGeC alloys grown on Si substrates

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Abstract

Metastable $\text{Si}_{1-x-y}\text{Ge}_x\text{C}_y$ alloys were grown by molecular beam epitaxy on (100) Si substrates. Solid elemental sources were used for the Si and Ge beams, and a resistively heated graphite filament was used for the C beam. Up to 3 at% of C was incorporated in the alloy layers. Optical transmission measurements showed that the absorption edge of thick layers increased to higher energies with increasing C fraction, and revealed the presence of Si–C and Ge–C vibrational modes in the infrared. At low temperatures, the alloys showed significant photoluminescence. The bandgap energies of thick layers increased linearly with the C fraction and followed a linear dependence of the bandgap on composition. Measurements of the valence band density of states using X-ray photoelectron spectroscopy indicated that the valence band energy maximum increased with the C fraction relative to that of SiGe alloys of similar composition. Our results indicated that SiGeC alloys are promising materials for Si-based heterostructure devices.

1. Introduction

Recently, alloys of the Group IV elements have become interesting for heterostructure devices compatible with Si integrated circuit technology. Research has been challenged by the low equilibrium solid solubility of C in Si and in Ge, but metastable $\text{Si}_{1-x-y}\text{Ge}_x\text{C}_y$ alloys with significant C atomic fractions have been grown by non-equilibrium techniques such as molecular beam epitaxy (MBE) [1] and chemical vapor deposition [2]. Although the equilibrium solubility of C is 10^{-6} in Si [3], and is 10^{-14} in Ge [4], we have incorporated up to 3 at% of C under the non-equilibrium growth conditions of

MBE. These alloys were solid solutions with a diamond cubic structure as indicated by X-ray diffraction [5]. An intriguing possibility is that the lattice constant of these alloys can be matched to that of Si by adjusting the composition ratios. In addition, the bandgap might be tunable to match desired optical wavelengths. The availability of optoelectronic heterostructures compatible with Si circuits would have a major impact on practical applications including microprocessors having monolithically integrated optical input/output channels [6].

Recent studies have focused on alloy growth conditions, structure, composition and luminescence [7–9]. Numerical values for physical properties and their dependence on composition are becoming more well known. Interpretation of alloy properties has been complicated by the effects of strain and by structural

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defects. Strain can reduce the bandgap energy, which is opposite to the alloying effect of adding C which increases the bandgap energy. The small atomic size of C relative to Si and Ge creates local strain and a locally distorted lattice. Therefore SiGeC alloys may behave as a new material with its own degree of strain [10].

In this work we describe the growth and properties of metastable random alloys of SiGeC. The alloys were grown by molecular beam epitaxy (MBE) using solid elemental sources, and the properties were measured by several analytical techniques. The alloys had a diamond cubic structure and the bandgap energy of thick layers depended linearly on composition.

2. The deposition system

Growth was performed in an EPI 620 MBE system comprising a growth chamber and a specimen introduction chamber. The growth chamber had six effusion cell ports and was equipped with reflection high energy electron diffraction (RHEED), optical pyrometry for substrate temperature measurement, and a quadrupole mass analyzer for residual gas analysis (RGA). The growth chamber was evacuated by a 400 l/s ion pump and a 1500 l/s cryopump, achieving a base pressure of 4×10^{-9} Pa. Panels in the growth temperature contained a circulating mixture of ethylene glycol and water to adsorb background gases, and to cool effusion cells and the substrate manipulator.

The Si source used float-zone refined intrinsic Si in a novel crucible of TiB₂ ceramic coated on the outside with W metal [11]. Using a high temperature effusion cell, the Si growth rate was 0.1 $\mu\text{m}/\text{h}$ at 1850°C. Above 1900°C, the TiB₂ ceramic began to decompose and small amounts of Ti and B impurities were incorporated into the alloy layers, as shown by secondary ion mass spectrometry (SIMS).

The Ge source was triple zone-refined polycrystalline Ge loaded into a pyrolytic boron nitride crucible. Using a standard temperature effusion cell, the Ge growth rate was 0.07 $\mu\text{m}/\text{h}$ at 1350°C. The Ge cell temperature was kept below 1400°C to avoid leaching B from the crucible and contaminating the Ge melt.

The C source was an electrical filament machined from pyrolytic graphite (PG), heated by applying a direct current. Only W metal and graphite were used near the C evaporation hot zone in the cell. Two types of PG with different purity levels were investigated, and the higher purity PG produced less CO and CO₂ (the principal impurities) during outgassing. RGA analysts showed that C₃ was the principal pure C molecule that was evaporated. At a filament current of 38 A, the effective C growth rate was 0.01 $\mu\text{m}/\text{h}$ at a filament temperature of 2030°C.

The substrates were 75 mm diameter, (100) oriented Si wafers. The wafers were degreased, etched in H₂O:H₂O₂:HCl (5:3:3), followed by HF:H₂O (1:10), and loaded into the introduction chamber [12]. In the growth chamber, substrates were outgassed at 250°C for 60 min. Substrate growth temperatures ranged from 400 to 600°C.

3. Alloy characterization

Film thicknesses were measured by optical interference and by stylus profilometry. For the C growth rate, we estimated an effective incorporation growth rate from the change in thickness of the alloys compared to pure Ge films grown under similar conditions. Transmission electron microscopy (TEM) indicated the crystal quality. X-ray diffraction was measured with a single crystal θ - 2θ diffractometer using CuK α radiation to determine the alloy structure. The SiGeC alloy films grown at 400°C had a polycrystalline diamond cubic structure with the (110) planes preferentially oriented parallel to the (100) Si substrate. GeC binary alloys grown at 600°C had a single crystal (100) diamond cubic structure oriented to the substrate. Applying Bragg's Law to the diffracted intensity peaks yielded the lattice constants.

Compositions were measured by Auger electron spectroscopy (AES), Rutherford backscattering spectrometry (RBS), SIMS, and by X-ray photoelectron spectroscopy (XPS). Prior to measurements, the surfaces were ion-sputtered until no surface oxygen was detectable. The fine structure of the Auger KLL signals indicated that the C formed sp³ bonds with neighboring atoms [13].

The optical absorbance was measured over a range

of wavelengths from the near to the far infrared (IR) by Fourier transform infrared spectroscopy (FTIR) in the transmission mode. Far IR absorption indicated infrared-active vibrational modes from Si–Ge, Si–C, and Ge–C. Near IR measurements yielded the optical absorption edge and the bandgap. Photoluminescence (PL) spectra were collected using a 1 m grating spectrometer with a liquid nitrogen-cooled Ge detector. Excitation was by a multi-line Ar ion laser operating at wavelengths of 488 and 514 nm, with a total laser beam power of 120 mW which was filtered and then focused to a 2 mm diameter spot. The samples were mounted in a liquid He cryostat for low temperature measurements.

XPS measurements yielded the valence band density of states in addition to the composition. From the energy of the valence band edge, it was possible to obtain the relative valence band offset energies versus composition which are important for heterostructure design. The conduction band offsets could then be inferred from the values for valence band offsets and the bandgap energies.

4. Results and discussion

4.1. Crystalline structure

X-ray diffraction showed intensity peaks corresponding to a diamond cubic lattice structure. Fig. 1 shows a typical plot of X-ray diffracted intensity

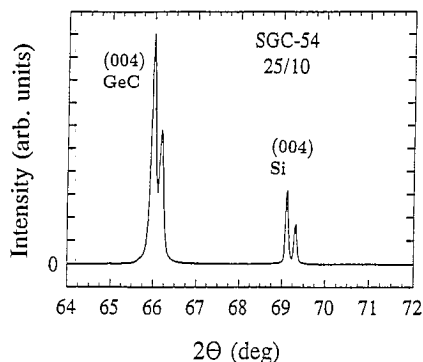


Fig. 1. X-ray diffraction intensity versus diffraction angle for a $\text{Ge}_{0.98}\text{C}_{0.02}$ alloy, showing reflections from the (004) lattice planes of the alloy at $2\theta = 66^\circ$ and of the Si substrate at $2\theta = 69.2^\circ$. Peak angles positions indicate a diamond cubic structure and the value for the lattice constant.

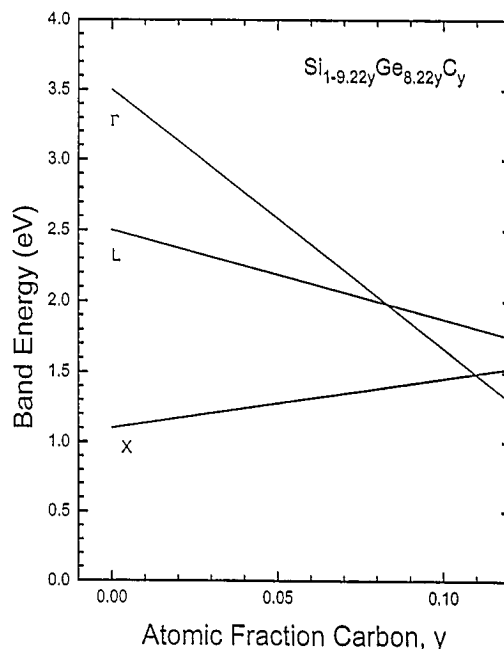


Fig. 2. Theoretical energies of conduction band minima based on linear interpolation from known Si, Ge and C endpoint values. This set of composition values was predicted to be lattice-matched to Si.

versus diffraction angle for a $\text{Ge}_{1-y}\text{C}_y$ alloy. Samples grown at 400°C had a polycrystalline structure with the (110) planes preferentially oriented to the (001) Si substrate. Samples grown at 600°C had (001) planes oriented parallel to the substrate. There was, however, a possibility of (001) plane grains being misoriented by an angle about the [001] growth direction. This was consistent with TEM measurements which showed twins and stacking faults at the alloy/substrate interface.

4.2. Dependence of bandgap on composition

Strain can reduce the bandgap of thin pseudomorphic alloy layers [14], and therefore we have investigated thick layers in order to obtain bulk values for the bandgap versus composition. Using tabulated band energies of pure Si, Ge, and C as the endpoints [15], Fig. 2 gives linearly interpolated theoretical values for the Γ ([000]), L ([111]), and X ([100]) conduction band minima with respect to the valence band maximum for the range of composition values, $\text{Si}_{1-9.22y}\text{Ge}_{8.22y}\text{C}_y$, predicted to be lattice-matched

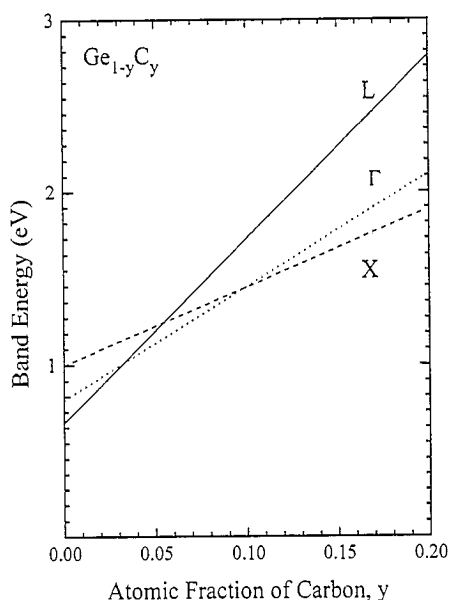


Fig. 3. Theoretical energies of the conduction band minima of binary $\text{Ge}_{1-y}\text{C}_y$ alloys, based on a linear interpolation.

to Si substrates. It is interesting that for the maximum value of $y = 0.11$, significant numbers of electrons may occupy both the X and the Γ valleys.

Fig. 3 shows theoretical band energies for binary $\text{Ge}_{1-y}\text{C}_y$ alloys. This binary alloy is lattice matched to Si only for $y = 0.11$, but the linear interpolation predicts the bandgap to be direct in k space for C atomic fractions $0.04 \leq y \leq 0.11$. The possibilities of direct bandgap Group IV semiconductors should have profound consequences for optical devices.

Table 1
Measured properties including sample number, composition, lattice constant a , bandgap E_g , and layer thickness t measured by optical interference; the calculated minimum bandgaps, $E_g(\text{calc})$, were determined by linear interpolation versus composition of the Γ, X , and L bands (as in Fig. 2), are for comparison; T_{sub} is the substrate growth temperature

Sample	Composition	a (nm)	E_g (eV)	t (μm)	$E_g(\text{calc})$ (eV)	T_{sub} ($^\circ\text{C}$)
SGC-19	$\text{Si}_{0.08}\text{Ge}_{0.90}\text{C}_{0.02}$	0.56348	1.046	0.49	1.041	400
SGC-20	$\text{Si}_{0.08}\text{Ge}_{0.91}\text{C}_{0.01}$	0.56394	0.991	0.47	0.956	400
SGC-30	$\text{Ge}_{0.99}\text{C}_{0.01}$	0.56544	0.732	0.582	–	600
SGC-31	$\text{Ge}_{0.98}\text{C}_{0.02}$	0.56539	0.782	0.139	–	600
SGC-32	$\text{Ge}_{0.97}\text{C}_{0.03}$	0.56525	0.875	0.136	–	600

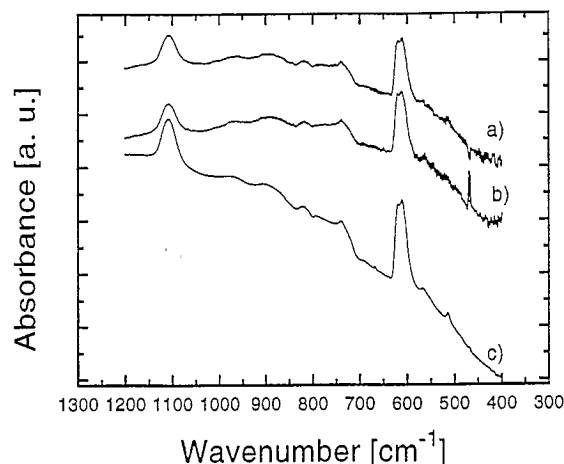
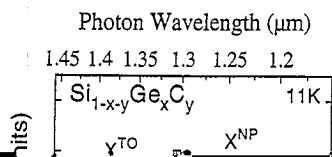


Fig. 4. Infrared absorbance versus photon wavenumber for $\text{Si}_{0.08}\text{Ge}_{0.90}\text{C}_{0.02}$ (top, a) and $\text{Si}_{0.08}\text{Ge}_{0.91}\text{C}_{0.01}$ (center, b) compared with pure Ge (bottom, c).

The experimental bandgaps of the SiGeC alloys were measured by two techniques: optical absorption and PL. From optical absorption, the bandgap was estimated from the energy at which the optical absorption coefficient $\alpha = 5 \text{ cm}^{-1}$. Table 1 gives the properties of several $\text{Si}_{1-x-y}\text{Ge}_x\text{C}_y$ alloys versus composition. Fig. 4 shows a plot of infrared absorbance versus photon wavenumber for samples of SiGeC. Absorption at 604 cm^{-1} is attributed to the localized vibrational mode of C in Si and to Si lattice modes [16]. There is indication of absorption at 566 cm^{-1} which is attributed to the localized vibrational mode of C in Ge [17].

Fig. 5 shows a plot of PL intensity versus photon energy for two samples of SiGeC at low temperatures. With increasing C fraction, the peaks shift to higher energies. Although the mechanism for the SiGeC PL is not yet clear, there is a strong similarity of these peaks to the PL of SiGe alloys [18], and to previous reports of PL from SiGeC [9]. Furthermore, the high energy peaks (labeled NP) match the energies expected for the bandgaps at the measured compositions, and lie higher in energy than defect lines known for SiGe alloys [19]. Therefore we have attributed the peaks to exciton recombination without phonons (NP) and to the phonon replicas (labeled TO).



4.3. Energy band offsets

Fig. 6 gives the energy distribution curves which are proportional to the valence band density of states

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